COE CST Tenth Annual Technical Meeting

241: High Temperature, Optical Sapphire Pressure Sensors

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# Agenda

- Team Members
- Task Description
- Schedule
- Goals
- Results
- Conclusions and Future Work



#### **Team Members**

- People
  - William S. Oates and Rajan Kumar
  - Jakob Consoliver-Zack
- Organizations
  - Florida Center for Advanced Aero-Propulsion
  - FAMU-FSU College of Engineering











## **Task Description**

- Development of high temperature pressure sensors (~1300°C)
  - Applications: Structural health monitoring, morphing surface control, combustion control
- Challenge: Sensor material limits, manufacturing
  - Sapphire used in prior research
    - Difficult to machine, multiple components
    - Laser machining affects material properties
    - Debonding of diaphragm is common failure mechanism
- Opportunity: High temperature mechanical characterization methods.
  - Understand laser machined properties
  - Conduct interface fracture and high temperature experiments to infer material properties and sensor performance.





## Schedule

- Conduct multi-axial x-ray measurements of laser machined sapphire—done
- Infer lattice properties, residual strain, and residual stress from laser machining—on-going
- Develop experimental set-up for interfacial fracture characterization—on-going
- Modify furnace internal structure for high temperature fracture measurements—planning stages
- Conduct high temperature fracture measurements—planning stages



## Goals

- Understand changes in sapphire properties as a function of laser machining
  - What is the internal residual stress and strain? Defect structures?
  - Critical to develop reliable sensors that can operate over a broad temperature range
- Understand bonding characteristics between sapphire and high temperature metals
  - Quantify strength and toughness of sapphire/platinum and refractory metal interfaces
  - Important to understand manufacturing pressure and temperature required to achieve a robust bond for high temperature sensing



- Examination of all data sets shows a very consistent strain state.
  - A single outlier is being further investigated
- Use of Bayesian UQ allows for a much greater reduction of uncertainty than conventional error methods.



Figure 2: Computed strain in plane direction with conventional uncertainty given by error bars vs Bayesian UQ



- Scan of the (104) plane could provide additional data of the strain state at depth.
- Decay of strain state can be approximated using exponential decay according to Beers' Law.
  - t: depth into machined zone
  - I<sub>c</sub>: penetration length of machined region





Figure 2: Computed strain in plane direction with potential (104) scan location overlaid.



- Finite Element Analysis (FEA) supports the existence of <u>compressive in-plane stresses</u> on the order of the yield strength of pristine of sapphire.
- Cross section and 1D views shown illustrating stress/strain surface decay from laser machined surface
- Surface compression provides higher global fracture toughness





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- Investigation of the fracture interface via FEA shows viable specimen geometries compatible with the existing testing setup.
- Crack length and fracture intensity K<sub>I</sub> can be inferred from coupled measured data and FEA modelling.





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#### Publications, Presentations, Awards, & Recognitions

#### **PUBLICATIONS:**

Consoliver-Zack, J., Rebar, D., Siegrist, T., Oates W. S., "Bayesian Uncertainty Analysis of the Residual Stress in Laser Machined Sapphire", in preparation, 2020. Bal Singh, H., Consoliver-Zack, J., Oates, W. S., "High-Temperature Mechanical Characterization of Laser-Machined Sapphire for High-Temperature Pressure Sensor Applications," *New Space*, v. 7 (1), 2019.



## **Conclusions and Future Work**

- Multiaxial x-ray data combined with Bayesian inference provided new insight on picosecond laser machined sapphire
  - Large compressive in-plane stress promising for enhanced toughness
  - Additional scan data planned to better infer strain through material thickness
- Models developed to ensure interface fracture can be resolved at temperatures >1000°C
  - FEA models and experimental sensor noise evaluated to provide high resolution increments in crack growth per load cycle
  - Refit furnace for high temperature testing
  - Conduct high temperature fracture experiments to characterize interface properties



## **COE CST ATM10 PRESENTATIONS**

- ATM10 Technical Presentations will be a video recording
  - There will be one recording for each active task, made by the grant recipient PI and/or their students
  - Prior tasks could be reviewed, if applicable
- The total duration of this video should be 10-15 minutes
  - Please fill in all information on all template pages
  - You can add slides to this presentation, but please do not exceed the time limit
  - Include photos and pictures whenever possible
- This video should use the set of charts provided in this file
- Please submit your video and the final Technical Presentation PowerPoint file to ken.davidian@faa.gov and fredbowen@orionat.com
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